REAL TIME CLOCK MODULE (SPI-Bus)

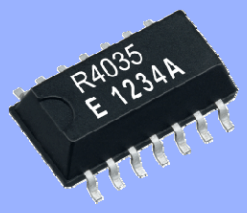
High-Stability Frequency with Built in Timestamp and Power Switching

RX - 4035 SA / LC

- Built-in 32.768 kHz crystal unit : Frequency adjusted for high accuracy. ($\pm 5 \times 10^{-6}$ / Ta = +25 °C)
- Interface Type : SPI-Bus (1MHz)
- Operating voltage range : 2.4 V to 5.5 V
- Timekeeping voltage range : 1.0 V to 5.5 V
- Low backup current : 350 nA (SA) 400 nA (LC) / 3 V (Typ.)
- Event detection and Time stamp : One-shot full timestamp and interrupt.
- Dual event detection ports : Each terminal has a de-bounce circuit.
- Auto power switching functions : When VDD deteriorates than 2.4V, internal source is switched to VBAT.

RoHS Compliant

Product Number (Please contact us)
RX-4035SA: X1B000192xxxx00
RX-4035LC: X1B000202xxxx00

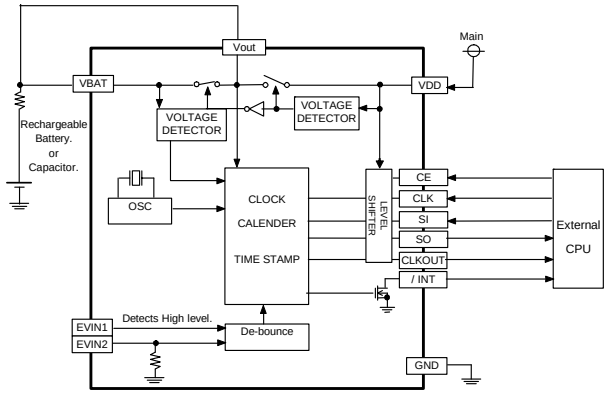




Actual size

RX-4035SA	RX-4035LC
	

Block diagram



Overview

- **The event detection and Timestamp function**
  Dual event detection terminals.
  Selectable de-bounce period 35ms or 2s.
  Available event detection interrupt output.

- **Power switching functions.**
  - When VDD is less than 2.4V, an internal source is switched to VBAT.
  - Note: When the supply from VBAT, SPI interface are disabled.

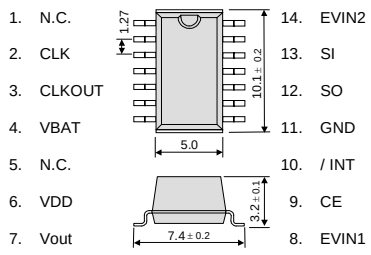
- **Alarm, Periodic interrupt, 32.768kHz clock output.**
  - Available monthly-alarm and weekly-alarm.
  - Interrupt period are selectable from 2Hz to Monthly.
  - CLKOUT outputs 32.768kHz clock powered by VDD.

Pin function

Signal Name	Input / Output	Function
VBAT	—	Power supply for backup.
Vout	Output	Switched power out. (maximum output current 20mA)
CE	Input	SPI chip enable.
CLK	Input	SPI serial clock.
SO	Output	SPI data out.
SI	Input	SPI data in.
GND	—	Ground
EVIN1	Input	Event detection input 1
EVIN2	Input	Event detection input 2
/ INT	Output	Interrupt out.
CLKOUT	Output	32.768kHz output. (CMOS. Can not inhibit.)
N.C.	—	Do not connect.
VDD	—	Main power supply.

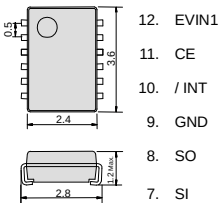
Terminal connection / External dimensions (Unit:mm)

RX – 4035 SA



SOP – 14 pin

RX – 4035 LC



VSOJ – 12pin

The metal case inside of the molding compound may be exposed on the top or bottom of this product.
This purely cosmetic and does not have any effect on quality, reliability or electrical specs.

***Stop using the glue**
Any glue must never use it after soldering LC-package to a circuit board.This product has glass on the back side of a package.When glue invasions between circuit board side and glass side, then glass cracks by thermal expansion of glue.In this case a crystal oscillation stops.Consider glue abolition or glue do not touch to LC-package

Specifications (characteristics)

* Refer to application manual for details.

■ Recommended Operating Conditions

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Operating voltage	VACCESS	VDD	2.4	3.0	5.5	V
Time keeping voltage	VCLK	VBAT	1.0	3.0	5.5	V
Operating temperature	TOPR	—	-40	+25	+85	°C
Storage temperature	TSTG	—	-55	—	+125	°C

■ Frequency characteristics

Item	Symbol	Conditions	Rating	Unit
Frequency tolerance	Δf / f	Ta = +25°C VBAT = 3.0 V	B: 5 ± 23 *1) AA: 5 ± 5 *2) AC: 0 ± 5 *2)	× 10^{-6}
Oscillation start-up time	tSTA	Ta = +25 °C VDD = 3.0 V	1 Max.	s
Frequency / voltage characteristics	f / V	Ta = +25 °C VDD = 2.4 V to 5.5 V	± 1 Max.	× 10^{-6}

*1) Equivalent to 1 minute of monthly deviation (excluding offset.)
*2) Equivalent to 13 seconds of monthly deviation (excluding offset.)

■ Current consumption characteristics

Ta = -40 °C to +85 °C

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Current Consumption	IBAT	RX-4035SA VBAT = 3.0V, VDD = 0.0V CE = 0V, CLKOUT = open	-	350	1200	nA
		RX-4035LC VBAT = 3.0V, VDD = 0.0V CE = 0V, CLKOUT = open		400		
	IDD	VDD = 3.0V CE = 0V CLKOUT = open	-	1.40	2.50	µA

■ Power supply detection voltage

Ta = -40 °C to +85 °C

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
VBAT detect voltage	VLOW	-	1.10	1.25	1.40	V
Power switching voltage (VDD to VBAT)	VD2B	+25 °C	2.328	2.40	2.472	V

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

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Pb Free	►Pb free.
RoHS Compliant	►Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
For Automotive	►Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
Automotive Safety	►Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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